

# MOS FIELD EFFECT TRANSISTOR 2SK3365

## SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

#### **DESCRIPTION**

The 2SK3365 is N-Channel MOS Field Effect Transistor designed for DC/DC converters application of notebook computers.

#### **FEATURES**

• Low on-resistance

 $R_{DS(on)1} = 14 \text{ m}\Omega \text{ (MAX.) (Vgs} = 10 \text{ V, ID} = 15 \text{ A)}$ 

 $R_{DS(on)2} = 21 \text{ m}\Omega \text{ (MAX.) (Vgs} = 4.5 \text{ V, ID} = 15 \text{ A)}$ 

RDS(on)3 = 29 m $\Omega$  (MAX.) (VGS = 4.0 V, ID = 15 A)

- Low Ciss : Ciss = 1300 pF (TYP.)
- · Built-in gate protection diode

### ORDERING INFORMATION

PART NUMBER	PACKAGE
2SK3365	TO-251
2SK3365-Z	TO-252

#### ABSOLUTE MAXIMUM RATINGS ( $T_A = 25$ °C)

Drain to Source Voltage (Vss = 0 V)	VDSS	30	V
Gate to Source Voltage (V <sub>DS</sub> = 0 V)	Vgss	±20	V
Drain Current (DC)	$I_{D(DC)}$	±30	Α
Drain Current (Pulse) Note	ID(pulse)	±120	Α
Total Power Dissipation (Tc = 25 °C)	Рт	36	W
Total Power Dissipation (T <sub>A</sub> = 25 °C)	Рт	1.0	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to + 150	°C

**Note** PW  $\leq$  10  $\mu$ s, Duty cycle  $\leq$  1 %

#### THERMAL RESISTANCE

Channel to case	Rth(ch-C)		°C/W	
Channel to ambient	Rth(ch-A)	125	°C/W	

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Not all devices/types available in every country. Please check with local NEC representative for availability and additional information.



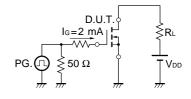
#### **ELECTRICAL CHARACTERISTICS (TA = 25 °C)**

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CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, ID = 15 A		11.5	14	mΩ
	RDS(on)2	Vgs = 4.5 V, ID = 15 A		15.2	21	mΩ
	RDS(on)3	Vgs = 4.0 V, ID = 15 A		18	29	mΩ
Gate to Source Cut-off Voltage	V <sub>GS(off)</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 1 mA	1.5	2.0	2.5	V
Forward Transfer Admittance	y <sub>fs</sub>	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 15 A	8.0	16.0		S
Drain Leakage Current	IDSS	V <sub>DS</sub> = 30 V, V <sub>GS</sub> = 0 V			10	μΑ
Gate to Source Leakage Current	Igss	Vgs = ±20 V, Vps = 0 V			±10	μΑ
Input Capacitance	Ciss	V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		1300		pF
Output Capacitance	Coss			405		pF
Reverse Transfer Capacitance	Crss			190		pF
Turn-on Delay Time	td(on)	$I_D = 15 \text{ A}, V_{GS(on)} = 10 \text{ V}, V_{DD} = 15 \text{ V},$		37		ns
Rise Time	tr	$R_G = 10 \Omega$		500		ns
Turn-off Delay Time	td(off)			75		ns
Fall Time	tf			95		ns
Total Gate Charge	QG	ID = 30 A, VDD = 24 V, VGS = 10 V		25		nC
Gate to Source Charge	Qgs			4.5		nC
Gate to Drain Charge	Q <sub>GD</sub>			7.0		nC
Body Diode forward Voltage	V <sub>F(S-D)</sub>	IF = 30 A, VGS = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 30 A, VGS = 0 V		35		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/μs		32		nC

#### **TEST CIRCUIT 1 SWITCHING TIME**

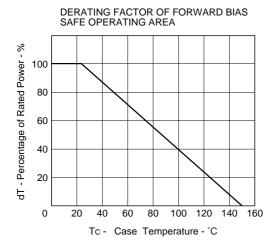
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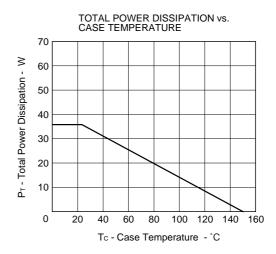
#### **TEST CIRCUIT 2 GATE CHARGE**



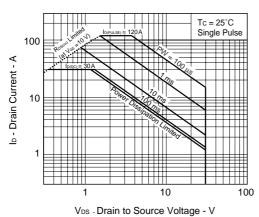


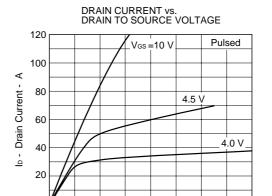
#### TYPICAL CHARACTERISTICS (TA = 25 °C)



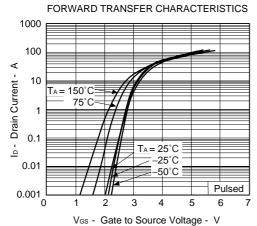










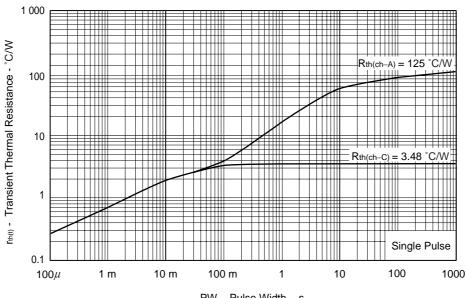


2  $V_{\text{\scriptsize DS}}$  -  $\,$  Drain to Source Voltage - V

3

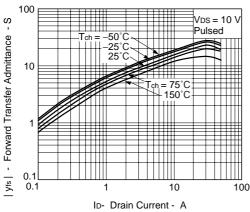
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#### TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

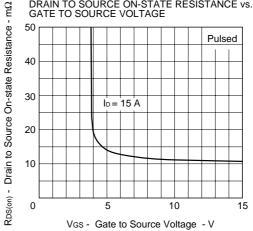


PW - Pulse Width - s

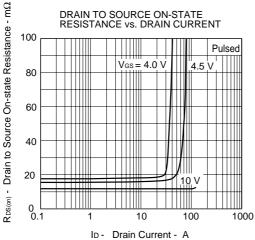




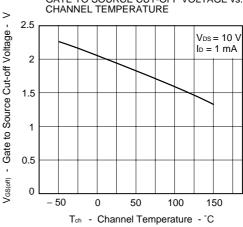
## DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



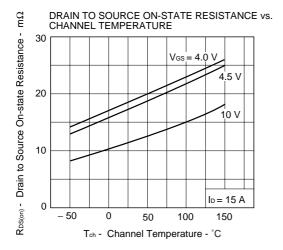
## DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT

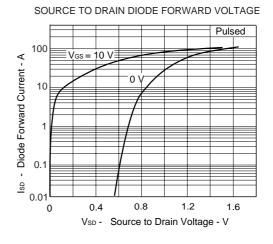


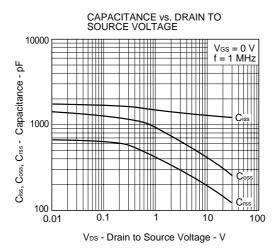
#### GATE TO SOURCE CUT-OFF VOLTAGE vs.

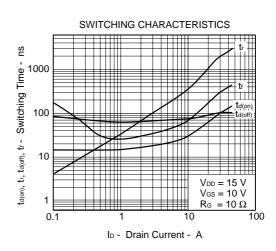


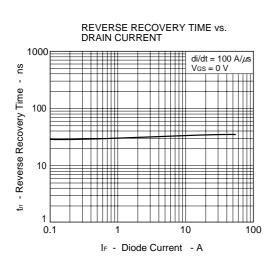


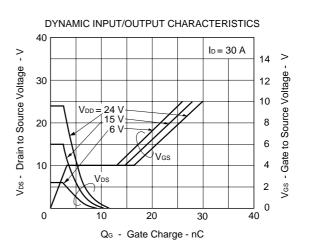










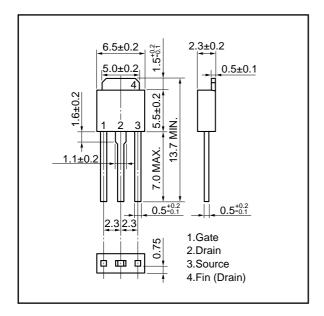


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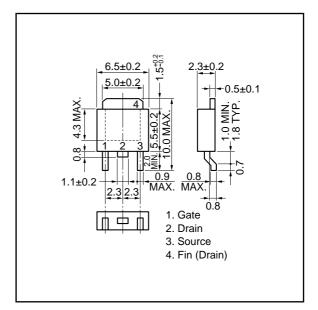


#### PACKAGE DRAWINGS (Unit: mm)

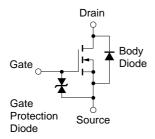
#### 1) TO-251 (MP-3)



#### 2) TO-252 (MP-3Z)



#### **EQUIVALENT CIRCUIT**



**Remark** The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

[MEMO]

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